MA2DF62

Silicon Mesa type

For high frequency rectification

■ Features

- Super high speed switching characteristic: $t_{rr} = 15$ ns (typ.)
- Low noise type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Repetitive peak reverse voltage	V _{RRM}	600	V	
Non-repetitive peak reverse surge voltage	V _{RSM}	600	V	
Forward current (Average) *1	I _{F(AV)}	10	A	
Non-repetitive peak forward surge current *2	I _{FSM} 40		A	
Junction temperature	T_j	150	°C	
Storage temperature	T _{stg}	-40 to +150	°C	

Note) *1: $T_C = 25^{\circ}C$

■ Package

• Code

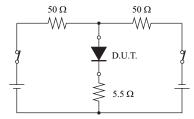
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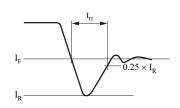
- Pin Name
 - 1: Cathode
 - 2: Anode
- Marking Symbol: MA2DF62

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_{\rm F} = 10 \rm A$		1.8	2.5	V
Reverse current	I _{RRM}	$V_{RRM} = 600 \text{ V}$			30	μΑ
Reverse recovery time *	t _{rr}	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}$ $I_{rr} = 0.25 \text{ A}$		15	25	ns
Thermal resistance (j-c)	R _{th(j-c)}				3.0	°C/W
Thermal resistance (j-a)	R _{th(j-a)}				63	°C/W

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. *: t_{rr} measurement circuit

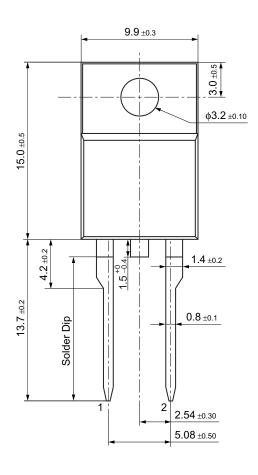


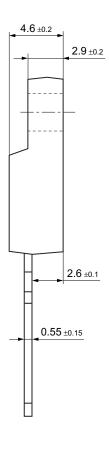


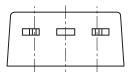
^{*2: 50} Hz sine wave 1 cycle (Non-repetitive peak current)

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Unit: mm







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